Zilog - ZGP323HAH2804G Datasheet





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Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	8MHz
Connectivity	-
Peripherals	HLVD, POR, WDT
Number of I/O	24
Program Memory Size	4KB (4K x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	237 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/zgp323hah2804g

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ZiLOG Worldwide Headquarters 532 Race Street

San Jose, CA 95126-3432 Telephone: 408.558.8500 Fax: 408.558.8300 www.zilog.com

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ZGP323H Product Specification



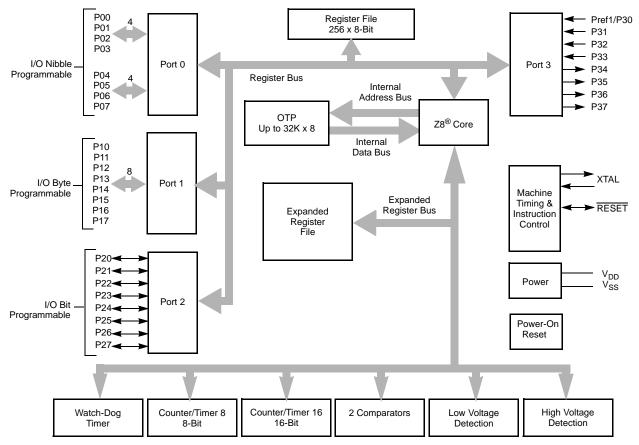
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Table 3. Power Connections

Connection	Circuit	Device	
Power	V _{CC}	V _{DD}	
Ground	GND	V _{SS}	



Note: Refer to the specific package for available pins.

Figure 1. Functional Block Diagram



Absolute Maximum Ratings

Stresses greater than those listed in Table 8 might cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period might affect device reliability.

Table 7. Absolute Maximum Ratings

Parameter	Minimum	Maximum	Units	Notes
Ambient temperature under bias	-40	125	° C	1
Storage temperature	-65	+150	° C	
Voltage on any pin with respect to V_{SS}	-0.3	7.0	V	2
Voltage on V_{DD} pin with respect to V_{SS}	-0.3	7.0	V	
Maximum current on input and/or inactive output pin	-5	+5	μA	
Maximum output current from active output pin	-25	+25	mA	
Maximum current into V_{DD} or out of V_{SS}		75	mA	
Notos:				

Notes:

1. See Ordering Information.

2. This voltage applies to all pins except the following: V_{DD}, P32, P33 and RESET.

Standard Test Conditions

The characteristics listed in this product specification apply for standard test conditions as noted. All voltages are referenced to GND. Positive current flows into the referenced pin (see Figure 7).

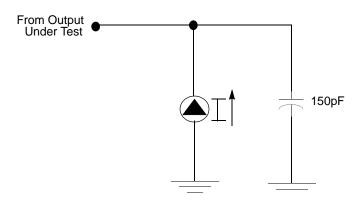


Figure 7. Test Load Diagram



Table 11. GP323HA DC Characteristics

			T _A = -40°C	C to +12	5°C			
Symbol	Parameter	V _{CC}	Min	Typ(7)	Max	Units	Conditions	Notes
V _{CC}	Supply Voltage		2.0		5.5	V	See Note 5	5
V _{CH}	Clock Input High Voltage	2.0-5.5	0.8 V _{CC}		V _{CC} +0.3	V	Driven by External Clock Generator	
V _{CL}	Clock Input Low Voltage	2.0-5.5	V _{SS} -0.3		0.4	V	Driven by External Clock Generator	
V _{IH}	Input High Voltage	2.0-5.5	0.7 V _{CC}		V _{CC} +0.3	V		
V _{IL}	Input Low Voltage	2.0-5.5	V _{SS} 0.3		0.2 V _{CC}	V		
V _{OH1}	Output High Voltage	2.0-5.5	V _{CC} -0.4			V	I _{OH} = -0.5mA	
V _{OH2}	Output High Voltage (P36, P37, P00, P01)	2.0-5.5	V _{CC} -0.8			V	I _{OH} = -7mA	
V _{OL1}	Output Low Voltage	2.0-5.5			0.4	V	$I_{OL} = 4.0 \text{mA}$	
V _{OL2}	Output Low Voltage (P00, P01, P36, P37)	2.0-5.5			0.8	V	I _{OL} = 10mA	
V _{OFFSET}	Comparator Input Offset Voltage	2.0-5.5			25	mV		
V _{REF}	Comparator Reference Voltage	2.0-5.5	0		V _{DD} -1.75	V		
IIL	Input Leakage	2.0-5.5	-1		1	μΑ	V _{IN} = 0V, V _{CC} Pull-ups disabled	
R _{PU}	Pull-up Resistance	2.0V	200		700	KΩ	V _{IN} = 0V; Pullups selected by mask	C C
		3.6V	50		300	KΩ	option	
		5.0V	25		175	KΩ	-	
I _{OL}	Output Leakage	2.0-5.5	-1		1	μA	$V_{IN} = 0V, V_{CC}$	
I _{CC}	Supply Current	2.0V		1	3	mA	at 8.0 MHz	1, 2
		3.6V		5	10	mA	at 8.0 MHz	1, 2
	0	5.5V		10	15	mA	at 8.0 MHz	1, 2
I _{CC1}	Standby Current	2.0V		0.5	1.6	mA	$V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6
	(HALT Mode)	3.6V 5.5V		0.8	2.0 3.2	mA m A	$V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6
1	Standby Current (Stan	2.0V		1.3 1.6	15	mA	$V_{IN} = 0V$, Clock at 8.0MHz	1, 2, 6 3
I _{CC2}	Standby Current (Stop Mode)	2.0V 3.6V		1.8	20	μA μA	$V_{IN} = 0 V, V_{CC} WDT$ not Running $V_{IN} = 0 V, V_{CC} WDT$ not Running	3
	wode)	5.5V		1.9	20 25	μA μA	$V_{IN} = 0 V, V_{CC} WDT not Running$ $V_{IN} = 0 V, V_{CC} WDT not Running$	3
		2.0V		5	30	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		3.6V		8	40	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
		5.5V		15	60	μA	$V_{IN} = 0 V, V_{CC} WDT$ is Running	3
I _{LV}	Standby Current (Low Voltage)			1.2	6	μA	Measured at 1.3V	4
V _{BO}	V _{CC} Low Voltage Protection			1.9	2.15	V	8MHz maximum Ext. CLK Freq.	
V _{LVD}	V _{CC} Low Voltage Detection			2.4		V	•	



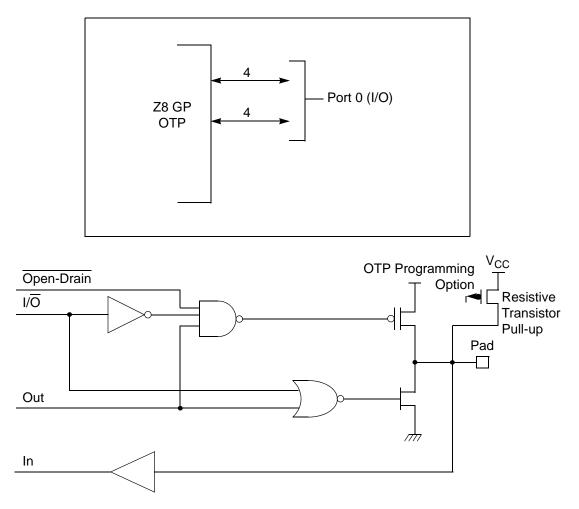


Figure 9. Port 0 Configuration

Port 1 (P17–P10)

Port 1 (see Figure 10) Port 1 can be configured for standard port input or output mode. After POR, Port 1 is configured as an input port. The output drivers are either push-pull or open-drain and are controlled by bit D1 in the PCON register.



Note: The Port 1 direction is reset to its default state following an SMR.



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The upper nibble of the register pointer (see Figure 16) selects which working register group, of 16 bytes in the register file, is accessed out of the possible 256. The lower nibble selects the expanded register file bank and, in the case of the Z8 GP family, banks 0, F, and D are implemented. A OH in the lower nibble allows the normal register file (bank 0) to be addressed. Any other value from 1H to FH exchanges the lower 16 registers to an expanded register bank.



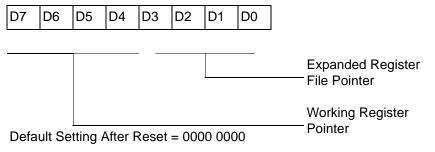


Figure 16. Register Pointer

Example: Z8 GP: (See Figure 15 on page 28)

R253 RP = 00h R0 = Port 0 R1 = Port 1 R2 = Port 2 R3 = Port 3

But if:

R253 RP = 0Dh R0 = CTR0 R1 = CTR1 R2 = CTR2R3 = Reserved



The counter/timers are mapped into ERF group D. Access is easily performed using the following:

LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	R0,#xx	;	load CTR0
LD	1, #xx	;	load CTR1
LD	R1, 2	;	CTR2→CTR1
LD	RP, #0Dh	;	Select ERF D
for access to bank D			
		;	(working
register group 0)			
LD	RP, #7Dh	;	Select
expanded register bank	D and working	;	register
group 7 of bank 0 for a	ccess.		
LD	71h, 2		
; CTRL2 \rightarrow register 71h			
LD	R1, 2		
; CTRL2 \rightarrow register 71h			

Register File

>

The register file (bank 0) consists of 4 I/O port registers, 237 general-purpose registers, 16 control and status registers (R0–R3, R4–R239, and R240–R255, respectively), and two expanded registers groups in Banks D (see Table 15) and F. Instructions can access registers directly or indirectly through an 8-bit address field, thereby allowing a short, 4-bit register address to use the Register Pointer (Figure 17). In the 4-bit mode, the register file is divided into 16 working register groups, each occupying 16 continuous locations. The Register Pointer addresses the starting location of the active working register group.





Field	Bit Position		Value	Description
Transmit_Submode/	32	R/W		Transmit Mode
Glitch_Filter			00*	Normal Operation
			01	Ping-Pong Mode
			10	T16_Out = 0
			11	T16_Out = 1
				Demodulation Mode
			00*	No Filter
			01	4 SCLK Cycle
			10	8 SCLK Cycle
			11	Reserved
Initial_T8_Out/	1-			Transmit Mode
Rising Edge		R/W	0*	T8_OUT is 0 Initially
			1	T8_OUT is 1 Initially
				Demodulation Mode
		R	0*	No Rising Edge
			1	Rising Edge Detected
		W	0	No Effect
			1	Reset Flag to 0
Initial_T16_Out/	0			Transmit Mode
Falling_Edge		R/W	0*	T16_OUT is 0 Initially
			1	T16_OUT is 1 Initially
				Demodulation Mode
		R	0*	No Falling Edge
			1	Falling Edge Detected
		W	0	No Effect
			1	Reset Flag to 0

Table 16.CTR1(0D)01H T8 and T16 Common Functions (Continued)

Note:

*Default at Power-On Reset

*Default at Power-On Reset. Not reset with Stop Mode recovery.

Mode

If the result is 0, the counter/timers are in TRANSMIT mode; otherwise, they are in DEMODULATION mode.

P36_Out/Demodulator_Input

In TRANSMIT Mode, this bit defines whether P36 is used as a normal output pin or the combined output of T8 and T16.

In DEMODULATION Mode, this bit defines whether the input signal to the Counter/Timers is from P20 or P31.

If the input signal is from Port 31, a capture event may also generate an IRQ2 interrupt. To prevent generating an IRQ2, either disable the IRQ2 interrupt by clearing its IMR bit D2 or use P20 as the input.





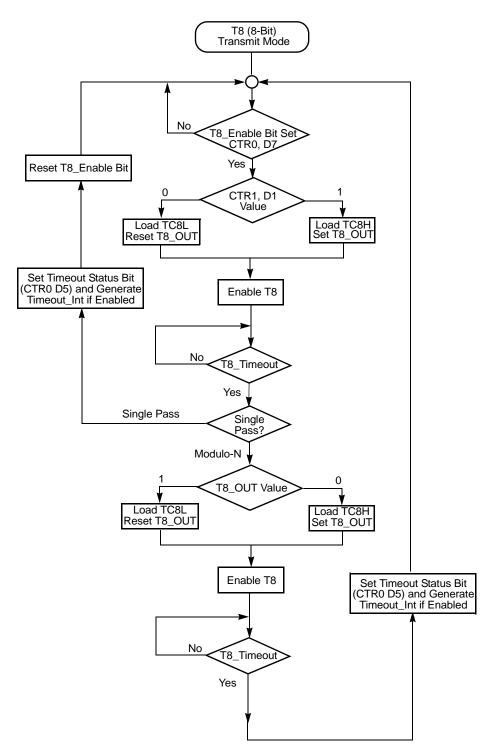


Figure 19. Transmit Mode Flowchart



Note: The letter h denotes hexadecimal values.

Transition from 0 to FFh is not a timeout condition.



Caution: Using the same instructions for stopping the counter/timers and setting the status bits is not recommended.

Two successive commands are necessary. First, the counter/timers must be stopped. Second, the status bits must be reset. These commands are required because it takes one counter/timer clock interval for the initiated event to actually occur. See Figure 21 and Figure 22.





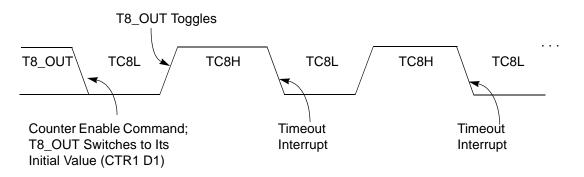


Figure 22. T8_OUT in Modulo-N Mode

T8 Demodulation Mode

The user must program TC8L and TC8H to FFH. After T8 is enabled, when the first edge (rising, falling, or both depending on CTR1, D5; D4) is detected, it starts to count down. When a subsequent edge (rising, falling, or both depending on CTR1, D5; D4) is detected during counting, the current value of T8 is complemented and put into one of the capture registers. If it is a positive edge, data is put





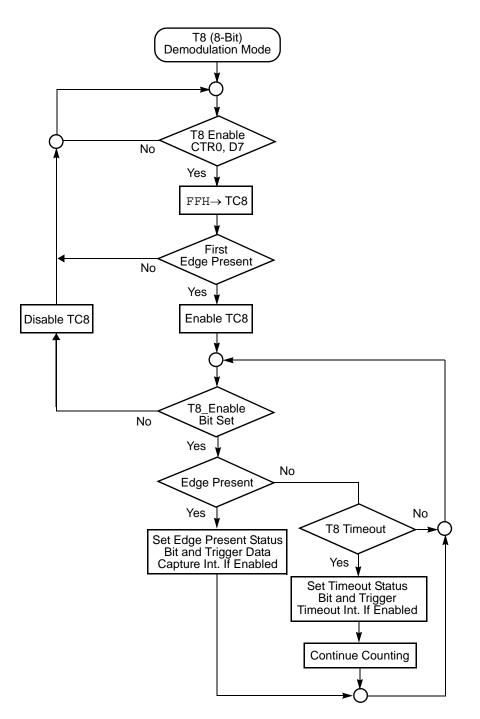


Figure 24. Demodulation Mode Flowchart



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During PING-PONG Mode

The enable bits of T8 and T16 (CTR0, D7; CTR2, D7) are set and cleared alternately by hardware. The timeout bits (CTR0, D5; CTR2, D5) are set every time the counter/timers reach the terminal count.

Interrupts

The ZGP323H features six different interrupts (Table 19). The interrupts are maskable and prioritized (Figure 30). The six sources are divided as follows: three sources are claimed by Port 3 lines P33–P31, two by the counter/timers (Table 19) and one for low voltage detection. The Interrupt Mask Register (globally or individually) enables or disables the six interrupt requests.

The source for IRQ is determined by bit 1 of the Port 3 mode register (P3M). When in digital mode, Pin P33 is the source. When in analog mode the output of the Stop mode recovery source logic is used as the source for the interrupt. See Figure 35, Stop Mode Recovery Source, on page 59.



Port 0 Output Mode (D2)

Bit 2 controls the output mode of port 0. A 1 in this location sets the output to push-pull, and a 0 sets the output to open-drain.

Stop-Mode Recovery Register (SMR)

This register selects the clock divide value and determines the mode of Stop Mode Recovery (Figure 33). All bits are write only except bit 7, which is read only. Bit 7 is a flag bit that is hardware set on the condition of Stop recovery and reset by a power-on cycle. Bit 6 controls whether a low level or a high level at the XORgate input (Figure 35 on page 59) is required from the recovery source. Bit 5 controls the reset delay after recovery. Bits D2, D3, and D4 of the SMR register specify the source of the Stop Mode Recovery signal. Bits D0 determines if SCLK/ TCLK are divided by 16 or not. The SMR is located in Bank F of the Expanded Register Group at address OBH.



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SMR(0F)0BH



* Default after Power On Reset or Watch-Dog Reset

* * Default setting after Reset and Stop Mode Recovery

* * * At the XOR gate input

* * * * Default setting after reset. Must be 1 if using a crystal or resonator clock source.

Figure 33. STOP Mode Recovery Register

SCLK/TCLK Divide-by-16 Select (D0)

D0 of the SMR controls a divide-by-16 prescaler of SCLK/TCLK (Figure 34). This control selectively reduces device power consumption during normal processor execution (SCLK control) and/or Halt Mode (where TCLK sources interrupt logic). After Stop Mode Recovery, this bit is set to a 0.



Stop Mode Recovery Register 2 (SMR2)

This register determines the mode of Stop Mode Recovery for SMR2 (Figure 36).

SMR2(0F)DH

D7	D6	D5	D4	D3	D2	D1	D0	
								 Reserved (Must be 0) Reserved (Must be 0) Stop-Mode Recovery Source 2 000 POR Only * 001 NAND P20, P21, P22, P23 010 NAND P20, P21, P22, P23, P24, P25, P26, P27 011 NOR P31, P32, P33 100 NAND P31, P32, P33 101 NOR P31, P32, P33, P00, P07 110 NAND P31, P32, P33, P00, P07 111 NAND P31, P32, P33, P20, P21, P22
								Reserved (Must be 0)
								Recovery Level * * 0 Low * 1 High
								Reserved (Must be 0)

Note: If used in conjunction with SMR, either of the two specified events causes a Stop-Mode Recovery.

* Default setting after reset

* * At the XOR gate input

Figure 36. Stop Mode Recovery Register 2 ((0F)DH:D2–D4, D6 Write Only)

If SMR2 is used in conjunction with SMR, either of the specified events causes a Stop Mode Recovery.



Note: Port pins configured as outputs are ignored as an SMR or SMR2 recovery source. For example, if the NAND or P23–P20 is selected as the recovery source and P20 is configured as an output, the remaining SMR pins (P23–P21) form the NAND equation.

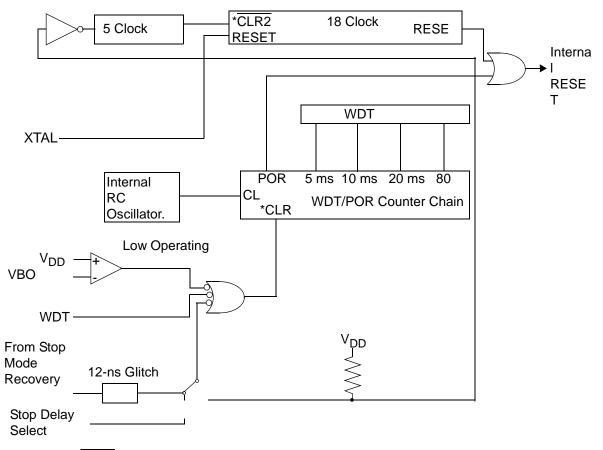


Table 23. Watch-Dog Timer Time Select

D1	D0	Timeout of Internal RC-Oscillator
0	0	5ms min.
0	1	10ms min.
1	0	20ms min.
1	1	80ms min.

WDTMR During Halt (D2)

This bit determines whether or not the WDT is active during HALT Mode. A 1 indicates active during HALT. The default is 1. See Figure 38.

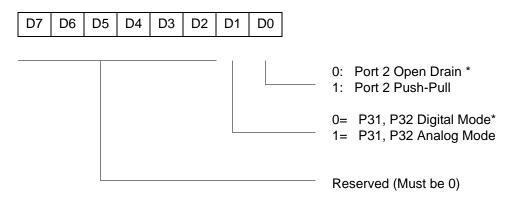


* CLR1 and CLR2 enable the WDT/POR and 18 Clock Reset timers respectively upon a Low-to-

Figure 38. Resets and WDT



R247 P3M(F7H)



* Default setting after reset. Not reset with a Stop Mode recovery.

Figure 49. Port 3 Mode Register (F7H: Write Only)







Figure 68. 48-Pin SSOP Package Design

Note: Check with ZiLOG on the actual bonding diagram and coordinate for chip-on-board assembly.

ZGP323H Z8[®] OTP Microcontroller with IR Timers



28-pin DIP/SOIC/SSOP 6 40- and 48-pin 8 40-pin DIP 7 48-pin SSOP 8 pin functions port 0 (P07 - P00) 18 port 0 (P17 - P10) 19 port 0 configuration 19 port 1 configuration 20 port 2 (P27 - P20) 20 port 2 (P37 - P30) 21 port 2 configuration 21 port 3 configuration 22 port 3 counter/timer configuration 24 reset) 25 XTAL1 (time-based input 18 XTAL2 (time-based output) 18 ping-pong mode 48 port 0 configuration 19 port 0 pin function 18 port 1 configuration 20 port 1 pin function 19 port 2 configuration 21 port 2 pin function 20 port 3 configuration 22 port 3 pin function 21 port 3counter/timer configuration 24 port configuration register 55 power connections 3 power supply 5 program memory 25 map 26 R ratings, absolute maximum 10 register 61 CTR(D)01h 35 CTR0(D)00h 33 CTR2(D)02h 37 CTR3(D)03h 39 flag 80 HI16(D)09h 32

HI8(D)0Bh 32 interrupt priority 78 interrupt request 79 interruptmask 79 L016(D)08h 32 L08(D)0Ah 32 LVD(D)0Ch 65 pointer 80 port 0 and 1 77 port 2 configuration 75 port 3 mode 76 port configuration 55, 75 SMR2(F)0Dh 40 stack pointer high 81 stack pointer low 81 stop mode recovery 57 stop mode recovery 2 61 stop-mode recovery 73 stop-mode recovery 274 T16 control 69 T8 and T16 common control functions 67 T8/T16 control 70 TC16H(D)07h 32 TC16L(D)06h 33 TC8 control 66 TC8H(D)05h 33 TC8L(D)04h 33 voltage detection 71 watch-dog timer 75 register description Counter/Timer2 LS-Byte Hold 33 Counter/Timer2 MS-Byte Hold 32 Counter/Timer8 Control 33 Counter/Timer8 High Hold 33 Counter/Timer8 Low Hold 33 CTR2 Counter/Timer 16 Control 37 CTR3 T8/T16 Control 39 Stop Mode Recovery2 40 T16 Capture LO 32 T8 and T16 Common functions 35 T8_Capture_HI 32